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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	C166
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, EBI/EMI, SPI, SSC, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	59
Program Memory Size	64KB (64K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	4.75V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	80-QFP
Supplier Device Package	PG-MQFP-80-7
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/c164ci8emcbkxqma1

Revision History:	**2001-05**	V2.0
Previous Version:	1999-08	
	1998-02	(Preliminary)
	04.97	(Advance Information)

Page	**Subjects (major changes since last revision)[1)]**
All	Converted to Infineon layout
1	Operating frequency up to 25 MHz
1 et al.	References to Flash removed
1	Timer Unit with three timers
1, 12, 73	On-chip XRAM described
2	Derivative table updated
10	Supply voltage is 5 V
21	Functionality of reduced CAPCOM6 corrected
22f	Timer description improved
29, 30	Sections “Oscillator Watchdog” and “Power Management” added
37	POCON reset values adjusted
41 to 73	Parameter section reworked

1) These changes refer to the last two versions. Version 1998-02 covers OTP and ROM derivatives, while version 1999-08 ist the most recent one.

Controller Area Network (CAN): License of Robert Bosch GmbH

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Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to:

mcdocu.comments@infineon.com

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin No.	Input Outp.	Function
P4		IO	Port 4 is a 6-bit bidirectional I/O port. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. Port 4 outputs can be configured as push/pull or open drain drivers. The input threshold of Port 4 is selectable (TTL or special). Port 4 can be used to output the segment address lines, the optional chip select lines, and for serial interface lines:[1)]
P4.0	17	O O	A16 Least Significant Segment Address Line, $\overline{CS3}$ Chip Select 3 Output
P4.1	18	O O	A17 Segment Address Line, $\overline{CS2}$ Chip Select 2 Output
P4.2	19	O O	A18 Segment Address Line, $\overline{CS1}$ Chip Select 1 Output
P4.3	22	O O	A19 Segment Address Line, $\overline{CS0}$ Chip Select 0 Output
P4.5	23	O I	A20 Segment Address Line, CAN1_RxD CAN 1 Receive Data Input
P4.6	24	O O	A21 Most Significant Segment Address Line, CAN1_TxD CAN 1 Transmit Data Output
$\overline{RD}$	25	O	External Memory Read Strobe. $\overline{RD}$ is activated for every external instruction or data read access.
$\overline{WR}$/ $\overline{WRL}$	26	O	External Memory Write Strobe. In $\overline{WR}$-mode this pin is activated for every external data write access. In $\overline{WRL}$-mode this pin is activated for low byte data write accesses on a 16-bit bus, and for every data write access on an 8-bit bus. See WRCFG in register SYSCON for mode selection.
ALE	27	O	Address Latch Enable Output. Can be used for latching the address into external memory or an address latch in the multiplexed bus modes.

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin No.	Input Outp.	Function
$\overline{EA}/V_{PP}$	28	I	External Access Enable pin. **A low level** at this pin during and after Reset forces the C164CI to latch the configuration from PORT0 and pin $\overline{RD}$, and to begin instruction execution out of external memory. **A high level** forces the C164CI to latch the configuration from pins $\overline{RD}$ and ALE, and to begin instruction execution out of the internal program memory. "ROMless" versions must have this pin tied to '0'. *Note: This pin also accepts the programming voltage for the OTP derivatives.*
PORT0 P0L.0-7 P0H.0-7	 29-36 37-39, 42-46	IO	PORT0 consists of the two 8-bit bidirectional I/O ports P0L and P0H. It is bit-wise programmable for input or output via direction bits. For a pin configured as input, the output driver is put into high-impedance state. In case of an external bus configuration, PORT0 serves as the address (A) and address/data (AD) bus in multiplexed bus modes and as the data (D) bus in demultiplexed bus modes. **Demultiplexed bus modes:** Data Path Width: 8-bit 16-bit P0L.0 – P0L.7: D0 – D7 D0 – D7 P0H.0 – P0H.7: I/O D8 – D15 **Multiplexed bus modes:** Data Path Width: 8-bit 16-bit P0L.0 – P0L.7: AD0 – AD7 AD0 – AD7 P0H.0 – P0H.7: A8 – A15 AD8 – AD15

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin No.	Input Outp.	Function
XTAL2 XTAL1	54 55	O I	XTAL2: Output of the oscillator amplifier circuit. XTAL1: Input to the oscillator amplifier and input to the internal clock generator To clock the device from an external source, drive XTAL1, while leaving XTAL2 unconnected. Minimum and maximum high/low and rise/fall times specified in the AC Characteristics must be observed.
$\overline{\text{RSTIN}}$	69	I/O	Reset Input with Schmitt-Trigger characteristics. A low level at this pin while the oscillator is running resets the C164CI. An internal pullup resistor permits power-on reset using only a capacitor connected to V_{SS}. A spike filter suppresses input pulses <10 ns. Input pulses >100 ns safely pass the filter. The minimum duration for a safe recognition should be 100 ns + 2 CPU clock cycles. In bidirectional reset mode (enabled by setting bit BDRSTEN in register SYSCON) the $\overline{\text{RSTIN}}$ line is internally pulled low for the duration of the internal reset sequence upon any reset (HW, SW, WDT). See note below this table.
$\overline{\text{RST}}$ $\overline{\text{OUT}}$	70	O	Internal Reset Indication Output. This pin is set to a low level when the part is executing either a hardware-, a software- or a watchdog timer reset. $\overline{\text{RSTOUT}}$ remains low until the EINIT (end of initialization) instruction is executed.
$\overline{\text{NMI}}$	71	I	Non-Maskable Interrupt Input. A high to low transition at this pin causes the CPU to vector to the NMI trap routine. When the PWRDN (power down) instruction is executed, the $\overline{\text{NMI}}$ pin must be low in order to force the C164CI to go into power down mode. If $\overline{\text{NMI}}$ is high, when PWRDN is executed, the part will continue to run in normal mode. If not used, pin $\overline{\text{NMI}}$ should be pulled high externally.

External Bus Controller

All of the external memory accesses are performed by a particular on-chip External Bus Controller (EBC). It can be programmed either to Single Chip Mode when no external memory is required, or to one of four different external memory access modes, which are as follows:

– 16-/18-/20-/22-bit Addresses, 16-bit Data, Demultiplexed
– 16-/18-/20-/22-bit Addresses, 16-bit Data, Multiplexed
– 16-/18-/20-/22-bit Addresses, 8-bit Data, Multiplexed
– 16-/18-/20-/22-bit Addresses, 8-bit Data, Demultiplexed

In the demultiplexed bus modes, addresses are output on PORT1 and data is input/ output on PORT0 or P0L, respectively. In the multiplexed bus modes both addresses and data use PORT0 for input/output.

Important timing characteristics of the external bus interface (Memory Cycle Time, Memory Tri-State Time, Length of ALE and Read Write Delay) have been made programmable to allow the user the adaption of a wide range of different types of memories and external peripherals.
In addition, up to 4 independent address windows may be defined (via register pairs ADDRSELx / BUSCONx) which control the access to different resources with different bus characteristics. These address windows are arranged hierarchically where BUSCON4 overrides BUSCON3 and BUSCON2 overrides BUSCON1. All accesses to locations not covered by these 4 address windows are controlled by BUSCON0.

Up to 4 external $\overline{CS}$ signals (3 windows plus default) can be generated in order to save external glue logic. The C164CI offers the possibility to switch the $\overline{CS}$ outputs to an unlatched mode. In this mode the internal filter logic is switched off and the $\overline{CS}$ signals are directly generated from the address. The unlatched $\overline{CS}$ mode is enabled by setting CSCFG (SYSCON.6).

For applications which require less than 4 MBytes of external memory space, this address space can be restricted to 1 MByte, 256 KByte, or to 64 KByte. In this case Port 4 outputs four, two, or no address lines at all. It outputs all 6 address lines, if an address space of 4 MBytes is used.

Note: When the on-chip CAN Module is used with the interface lines assigned to Port 4, the CAN lines override the segment address lines and the segment address output on Port 4 is therefore limited to 4 bits i.e. address lines A19 … A16.

Central Processing Unit (CPU)

The main core of the CPU consists of a 4-stage instruction pipeline, a 16-bit arithmetic and logic unit (ALU) and dedicated SFRs. Additional hardware has been spent for a separate multiply and divide unit, a bit-mask generator and a barrel shifter.

Based on these hardware provisions, most of the C164CI's instructions can be executed in just one machine cycle which requires 2 CPU clocks (4 TCL). For example, shift and rotate instructions are always processed during one machine cycle independent of the number of bits to be shifted. All multiple-cycle instructions have been optimized so that they can be executed very fast as well: branches in 2 cycles, a 16 × 16 bit multiplication in 5 cycles and a 32-/16-bit division in 10 cycles. Another pipeline optimization, the so-called 'Jump Cache', reduces the execution time of repeatedly performed jumps in a loop from 2 cycles to 1 cycle.

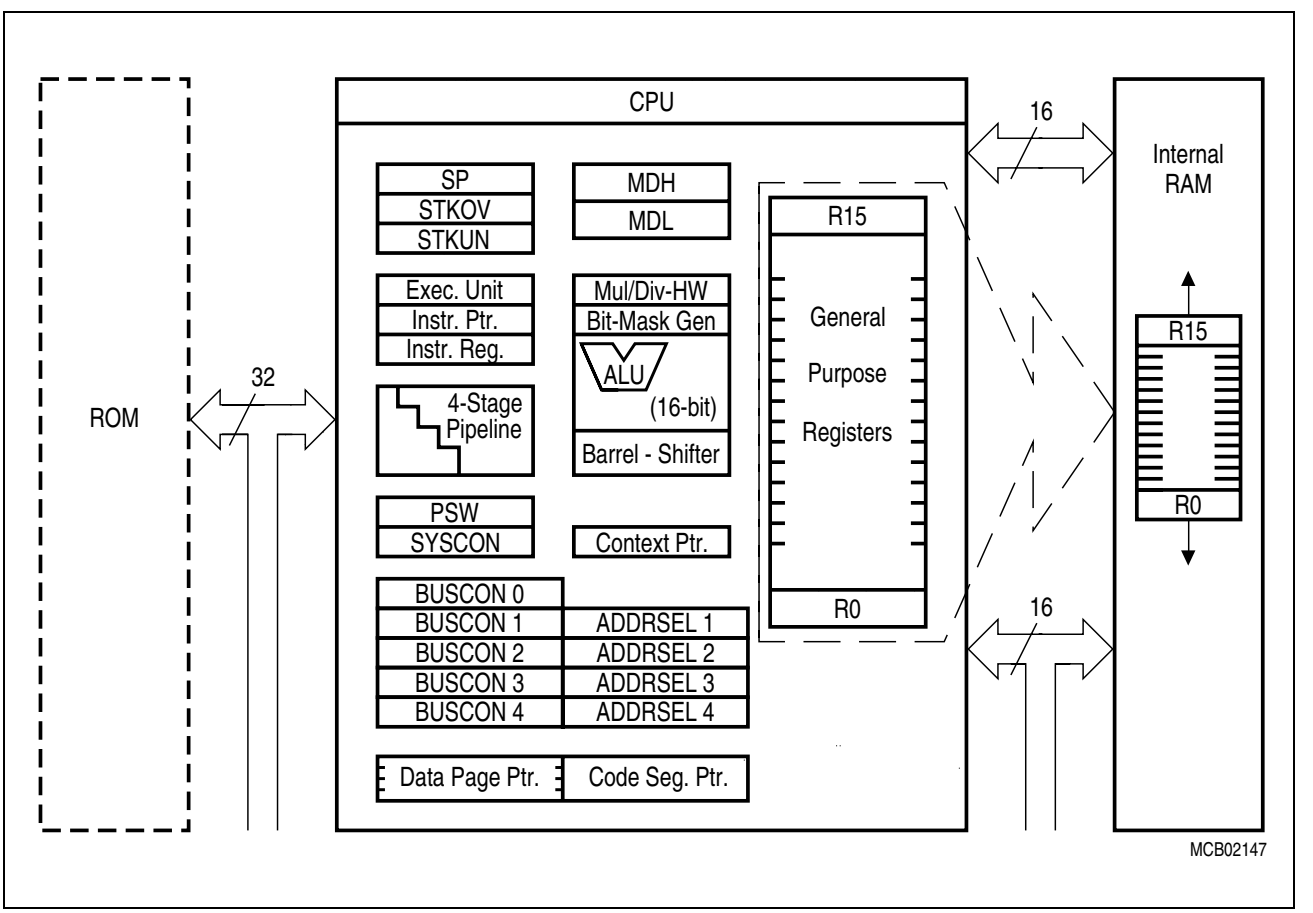


Figure 4 CPU Block Diagram

Interrupt System

With an interrupt response time within a range from just 5 to 12 CPU clocks (in case of internal program execution), the C164CI is capable of reacting very fast to the occurrence of non-deterministic events.

The architecture of the C164CI supports several mechanisms for fast and flexible response to service requests that can be generated from various sources internal or external to the microcontroller. Any of these interrupt requests can be programmed to being serviced by the Interrupt Controller or by the Peripheral Event Controller (PEC).

In contrast to a standard interrupt service where the current program execution is suspended and a branch to the interrupt vector table is performed, just one cycle is ‘stolen’ from the current CPU activity to perform a PEC service. A PEC service implies a single byte or word data transfer between any two memory locations with an additional increment of either the PEC source or the destination pointer. An individual PEC transfer counter is implicity decremented for each PEC service except when performing in the continuous transfer mode. When this counter reaches zero, a standard interrupt is performed to the corresponding source related vector location. PEC services are very well suited, for example, for supporting the transmission or reception of blocks of data. The C164CI has 8 PEC channels each of which offers such fast interrupt-driven data transfer capabilities.

A separate control register which contains an interrupt request flag, an interrupt enable flag and an interrupt priority bitfield exists for each of the possible interrupt sources. Via its related register, each source can be programmed to one of sixteen interrupt priority levels. Once having been accepted by the CPU, an interrupt service can only be interrupted by a higher prioritized service request. For the standard interrupt processing, each of the possible interrupt sources has a dedicated vector location.

Fast external interrupt inputs are provided to service external interrupts with high precision requirements. These fast interrupt inputs feature programmable edge detection (rising edge, falling edge or both edges).

Software interrupts are supported by means of the ‘TRAP’ instruction in combination with an individual trap (interrupt) number.

Table 3 shows all of the possible C164CI interrupt sources and the corresponding hardware-related interrupt flags, vectors, vector locations and trap (interrupt) numbers.

Note: Interrupt nodes which are not used by associated peripherals, may be used to generate software controlled interrupt requests by setting the respective interrupt request bit (xIR).

General Purpose Timer (GPT) Unit

The GPT unit represents a very flexible multifunctional timer/counter structure which may be used for many different time related tasks such as event timing and counting, pulse width and duty cycle measurements, pulse generation, or pulse multiplication.

The GPT unit incorporates three 16-bit timers. Each timer may operate independently in a number of different modes, or may be concatenated with another timer.

Each of the three timers T2, T3, T4 of **module GPT1** can be configured individually for one of four basic modes of operation, which are Timer, Gated Timer, Counter, and Incremental Interface Mode. In Timer Mode, the input clock for a timer is derived from the CPU clock, divided by a programmable prescaler, while Counter Mode allows a timer to be clocked in reference to external events.
Pulse width or duty cycle measurement is supported in Gated Timer Mode, where the operation of a timer is controlled by the ‘gate’ level on an external input pin. For these purposes, each timer has one associated port pin (TxIN) which serves as gate or clock input. The maximum resolution of the timers in module GPT1 is 16 TCL.

The count direction (up/down) for each timer is programmable by software or may additionally be altered dynamically by an external signal on a port pin (TxEUD) to facilitate e.g. position tracking.

In Incremental Interface Mode the GPT1 timers (T2, T3, T4) can be directly connected to the incremental position sensor signals A and B via their respective inputs TxIN and TxEUD. Direction and count signals are internally derived from these two input signals, so the contents of the respective timer Tx corresponds to the sensor position. The third position sensor signal TOP0 can be connected to an interrupt input.

Timer T3 has an output toggle latch (T3OTL) which changes its state on each timer over-flow/underflow. The state of this latch may be used internally to clock timers T2 and T4 for measuring long time periods with high resolution.

In addition to their basic operating modes, timers T2 and T4 may be configured as reload or capture registers for timer T3. When used as capture or reload registers, timers T2 and T4 are stopped. The contents of timer T3 is captured into T2 or T4 in response to a signal at their associated input pins (TxIN). Timer T3 is reloaded with the contents of T2 or T4 triggered either by an external signal or by a selectable state transition of its toggle latch T3OTL.

CAN-Module

The integrated CAN-Module handles the completely autonomous transmission and reception of CAN frames in accordance with the CAN specification V2.0 part B (active), i.e. the on-chip CAN-Modules can receive and transmit standard frames with 11-bit identifiers as well as extended frames with 29-bit identifiers.

The module provides Full CAN functionality on up to 15 message objects. Message object 15 may be configured for Basic CAN functionality. Both modes provide separate masks for acceptance filtering which allows to accept a number of identifiers in Full CAN mode and also allows to disregard a number of identifiers in Basic CAN mode. All message objects can be updated independent from the other objects and are equipped for the maximum message length of 8 bytes.

The bit timing is derived from the XCLK and is programmable up to a data rate of 1 Mbit/s. Each CAN-Module uses two pins of Port 4 or Port 8 to interface to an external bus transceiver. The interface pins are assigned via software.

Note: When the CAN interface is assigned to Port 4, the respective segment address lines on Port 4 cannot be used. This will limit the external address space.

Watchdog Timer

The Watchdog Timer represents one of the fail-safe mechanisms which have been implemented to prevent the controller from malfunctioning for longer periods of time.

The Watchdog Timer is always enabled after a reset of the chip, and can only be disabled in the time interval until the EINIT (end of initialization) instruction has been executed. Thus, the chip's start-up procedure is always monitored. The software has to be designed to service the Watchdog Timer before it overflows. If, due to hardware or software related failures, the software fails to do so, the Watchdog Timer overflows and generates an internal hardware reset and pulls the $\overline{\text{RSTOUT}}$ pin low in order to allow external hardware components to be reset.

The Watchdog Timer is a 16-bit timer, clocked with the system clock divided by 2/4/128/256. The high byte of the Watchdog Timer register can be set to a prespecified reload value (stored in WDTREL) in order to allow further variation of the monitored time interval. Each time it is serviced by the application software, the high byte of the Watchdog Timer is reloaded. Thus, time intervals between 20 µs and 336 ms can be monitored (@ 25 MHz).
The default Watchdog Timer interval after reset is 5.24 ms (@ 25 MHz).

Parallel Ports

The C164CI provides up to 59 I/O lines which are organized into five input/output ports and one input port. All port lines are bit-addressable, and all input/output lines are individually (bit-wise) programmable as inputs or outputs via direction registers. The I/O ports are true bidirectional ports which are switched to high impedance state when configured as inputs. The output drivers of three I/O ports can be configured (pin by pin) for push/pull operation or open-drain operation via control registers. During the internal reset, all port pins are configured as inputs.

The input threshold of Port 3, Port 4, and Port 8 is selectable (TTL or CMOS like), where the special CMOS like input threshold reduces noise sensitivity due to the input hysteresis. The input threshold may be selected individually for each byte of the respective ports.

All port lines have programmable alternate input or output functions associated with them. All port lines that are not used for these alternate functions may be used as general purpose IO lines.

PORT0 and PORT1 may be used as address and data lines when accessing external memory, while Port 4 outputs the additional segment address bits A21/19/17 … A16 and the optional chip select signals in systems where segmentation is enabled to access more than 64 KBytes of memory.
Ports P1L, P1H, and P8 are associated with the capture inputs or compare outputs of the CAPCOM units and/or serve as external interrupt inputs.
Port 3 includes alternate functions of timers, serial interfaces, the optional bus control signal $\overline{\text{BHE}}$/$\overline{\text{WRH}}$, and the system clock output CLKOUT (or the programmable frequency output FOUT).
Port 5 is used for the analog input channels to the A/D converter or timer control signals.

The edge characteristics (transition time) and driver characteristics (output current) of the C164CI's port drivers can be selected via the Port Output Control registers (POCONx).

Power Management

The C164CI provides several means to control the power it consumes either at a given time or averaged over a certain timespan. Three mechanisms can be used (partly in parallel):

- **Power Saving Modes** switch the C164CI into a special operating mode (control via instructions).
  Idle Mode stops the CPU while the peripherals can continue to operate.
  Sleep Mode and Power Down Mode stop all clock signals and all operation (RTC may optionally continue running). Sleep Mode can be terminated by external interrupt signals.
- **Clock Generation Management** controls the distribution and the frequency of internal and external clock signals (control via register SYSCON2).
  Slow Down Mode lets the C164CI run at a CPU clock frequency of f_{OSC}/1 … 32 (half for prescaler operation) which drastically reduces the consumed power. The PLL can be optionally disabled while operating in Slow Down Mode.
  External circuitry can be controlled via the programmable frequency output FOUT.
- **Peripheral Management** permits temporary disabling of peripheral modules (control via register SYSCON3).
  Each peripheral can separately be disabled/enabled. A group control option disables a major part of the peripheral set by setting one single bit.

The on-chip RTC supports intermittend operation of the C164CI by generating cyclic wakeup signals. This offers full performance to quickly react on action requests while the intermittend sleep phases greatly reduce the average power consumption of the system.

Table 7 C164CI Registers, Ordered by Name (cont'd)

Name	Physical Address	8-Bit Addr.	Description	Reset Value
OPDAT	$EDC4_H$ **X**	---	OTP Progr. Interface Data Register	0000_H
P0H b	$FF02_H$	81_H	Port 0 High Reg. (Upper half of PORT0)	00_H
P0L b	$FF00_H$	80_H	Port 0 Low Reg. (Lower half of PORT0)	00_H
P1H b	$FF06_H$	83_H	Port 1 High Reg. (Upper half of PORT1)	00_H
P1L b	$FF04_H$	82_H	Port 1 Low Reg. (Lower half of PORT1)	00_H
P3 b	$FFC4_H$	$E2_H$	Port 3 Register	0000_H
P4 b	$FFC8_H$	$E4_H$	Port 4 Register (7 bits)	00_H
P5 b	$FFA2_H$	$D1_H$	Port 5 Register (read only)	$XXXX_H$
P5DIDIS b	$FFA4_H$	$D2_H$	Port 5 Digital Input Disable Register	0000_H
P8 b	$FFD4_H$	EA_H	Port 8 Register (8 bits)	00_H
PECC0	$FEC0_H$	60_H	PEC Channel 0 Control Register	0000_H
PECC1	$FEC2_H$	61_H	PEC Channel 1 Control Register	0000_H
PECC2	$FEC4_H$	62_H	PEC Channel 2 Control Register	0000_H
PECC3	$FEC6_H$	63_H	PEC Channel 3 Control Register	0000_H
PECC4	$FEC8_H$	64_H	PEC Channel 4 Control Register	0000_H
PECC5	$FECA_H$	65_H	PEC Channel 5 Control Register	0000_H
PECC6	$FECC_H$	66_H	PEC Channel 6 Control Register	0000_H
PECC7	$FECE_H$	67_H	PEC Channel 7 Control Register	0000_H
PICON b	$F1C4_H$ **E**	$E2_H$	Port Input Threshold Control Register	0000_H
POCON0H	$F082_H$ **E**	41_H	Port P0H Output Control Register	0011_H
POCON0L	$F080_H$ **E**	40_H	Port P0L Output Control Register	0011_H
POCON1H	$F086_H$ **E**	43_H	Port P1H Output Control Register	0011_H
POCON1L	$F084_H$ **E**	42_H	Port P1L Output Control Register	0011_H
POCON20	$F0AA_H$ **E**	55_H	Dedicated Pin Output Control Register	0000_H
POCON3	$F08A_H$ **E**	45_H	Port P3 Output Control Register	2222_H
POCON4	$F08C_H$ **E**	46_H	Port P4 Output Control Register	0010_H
POCON8	$F092_H$ **E**	49_H	Port P8 Output Control Register	0022_H
PSW b	$FF10_H$	88_H	CPU Program Status Word	0000_H
RP0H b	$F108_H$ **E**	84_H	System Startup Config. Reg. (Rd. only)	XX_H
RSTCON b	$F1E0_H$ **m**	---	Reset Control Register	$00XX_H$

Absolute Maximum Ratings

Table 8 Absolute Maximum Rating Parameters

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		
Storage temperature	T_{ST}	-65	150	°C	–
Junction temperature	T_J	-40	150	°C	under bias
Voltage on V_{DD} pins with respect to ground (V_{SS})	V_{DD}	-0.5	6.5	V	–
Voltage on any pin with respect to ground (V_{SS})	V_{IN}	-0.5	V_{DD} + 0.5	V	–
Input current on any pin during overload condition	–	-10	10	mA	–
Absolute sum of all input currents during overload condition	–	–	|100|	mA	–
Power dissipation	P_{DISS}	–	1.5	W	–

Note: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
During absolute maximum rating overload conditions ($V_{IN} > V_{DD}$ or $V_{IN} < V_{SS}$) the voltage on V_{DD} pins with respect to ground (V_{SS}) must not exceed the values defined by the absolute maximum ratings.

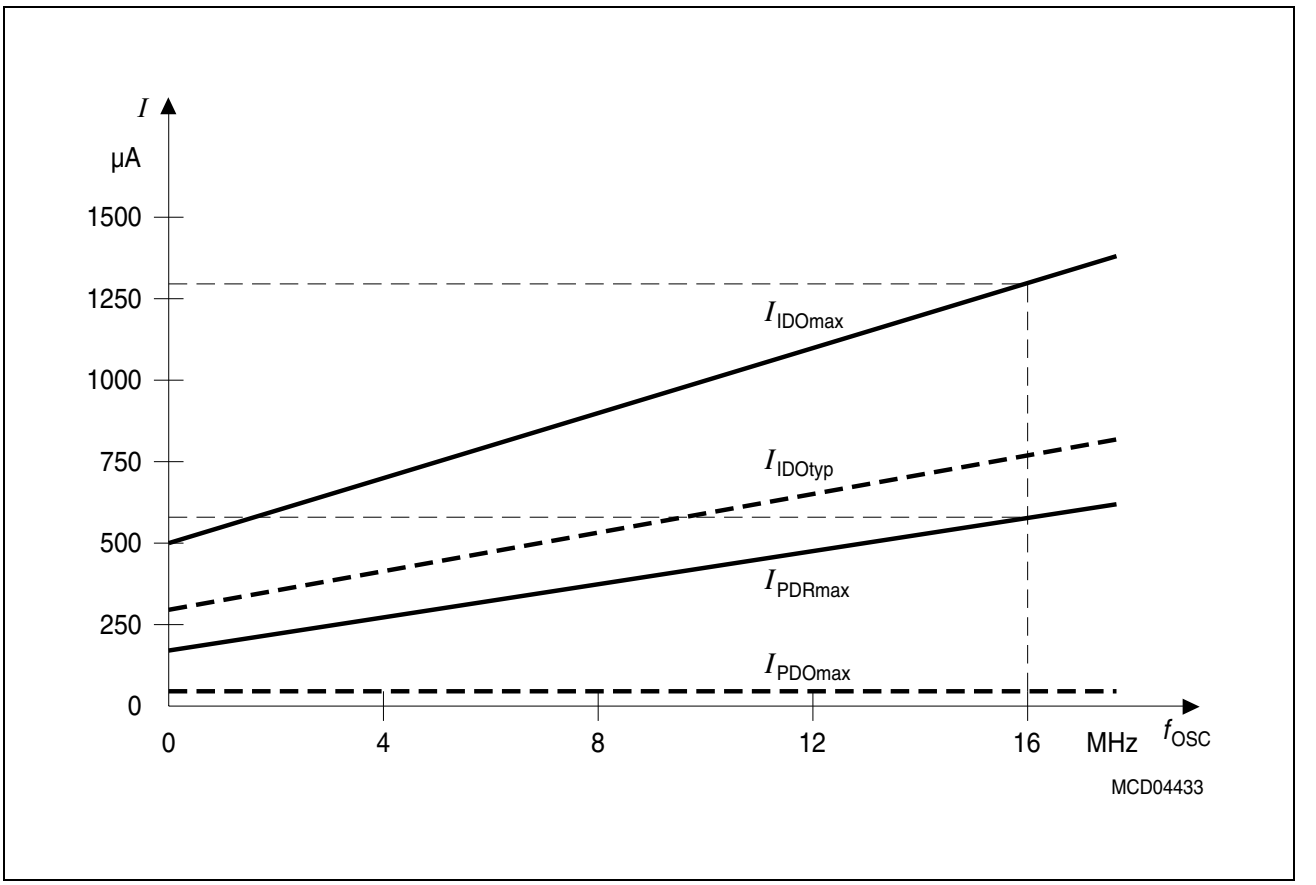


Figure 8 **Idle and Power Down Supply Current as a Function of Oscillator Frequency**

AC Characteristics
External Clock Drive XTAL1
(Operating Conditions apply)

Table 12 External Clock Drive Characteristics

Parameter	Symbol		Direct Drive 1:1		Prescaler 2:1		PLL 1:N		Unit
			min.	max.	min.	max.	min.	max.	
Oscillator period	t_{OSC}	SR	40	–	20	–	60[1]	500[1]	ns
High time[2]	t_1	SR	20[3]	–	6	–	10	–	ns
Low time[2]	t_2	SR	20[3]	–	6	–	10	–	ns
Rise time[2]	t_3	SR	–	8	–	5	–	10	ns
Fall time[2]	t_4	SR	–	8	–	5	–	10	ns

1) The minimum and maximum oscillator periods for PLL operation depend on the selected CPU clock generation mode. Please see respective table above.

2) The clock input signal must reach the defined levels V_{IL2} and V_{IH2}.

3) The minimum high and low time refers to a duty cycle of 50%. The maximum operating freqency (f_{CPU}) in direct drive mode depends on the duty cycle of the clock input signal.

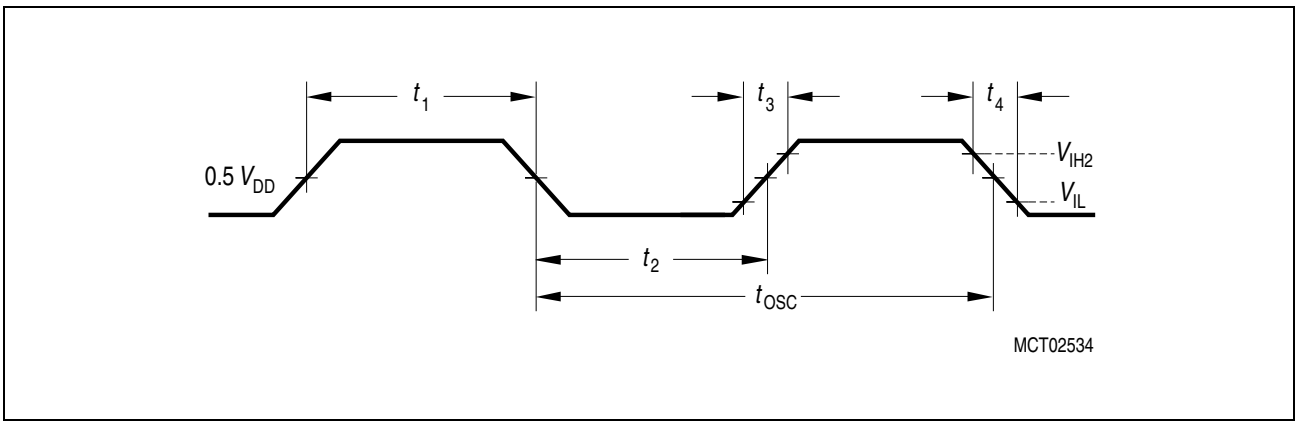


Figure 13 External Clock Drive XTAL1

Note: If the on-chip oscillator is used together with a crystal, the oscillator frequency is limited to a range of 4 MHz to 16 MHz.
It is strongly recommended to measure the oscillation allowance (or margin) in the final target system (layout) to determine the optimum parameters for the oscillator operation. Please refer to the limits specified by the crystal supplier.
When driven by an external clock signal it will accept the specified frequency range. Operation at lower input frequencies is possible but is guaranteed by design only (not 100% tested).

8) During the sample time the input capacitance C_{AIN} can be charged/discharged by the external source. The internal resistance of the analog source must allow the capacitance to reach its final voltage level within t_S. After the end of the sample time t_S, changes of the analog input voltage have no effect on the conversion result. Values for the sample time t_S depend on programming and can be taken from **Table 14**.

Sample time and conversion time of the C164CI's A/D Converter are programmable. **Table 14** should be used to calculate the above timings.
The limit values for f_{BC} must not be exceeded when selecting ADCTC.

Table 14 A/D Converter Computation Table

ADCON.15|14 (ADCTC)	A/D Converter Basic Clock f_{BC}	ADCON.13|12 (ADSTC)	Sample time t_S
00	f_{CPU} / 4	00	$t_{BC} \times 8$
01	f_{CPU} / 2	01	$t_{BC} \times 16$
10	f_{CPU} / 16	10	$t_{BC} \times 32$
11	f_{CPU} / 8	11	$t_{BC} \times 64$

Converter Timing Example:

Assumptions: f_{CPU} = 25 MHz (i.e. t_{CPU} = 40 ns), ADCTC = '00', ADSTC = '00'.
Basic clock f_{BC} = f_{CPU}/4 = 6.25 MHz, i.e. t_{BC} = 160 ns.
Sample time t_S = $t_{BC} \times 8$ = 1280 ns.
Conversion time t_C = t_S + 40 t_{BC} + 2 t_{CPU} = (1280 + 6400 + 80) ns = 7.8 µs.

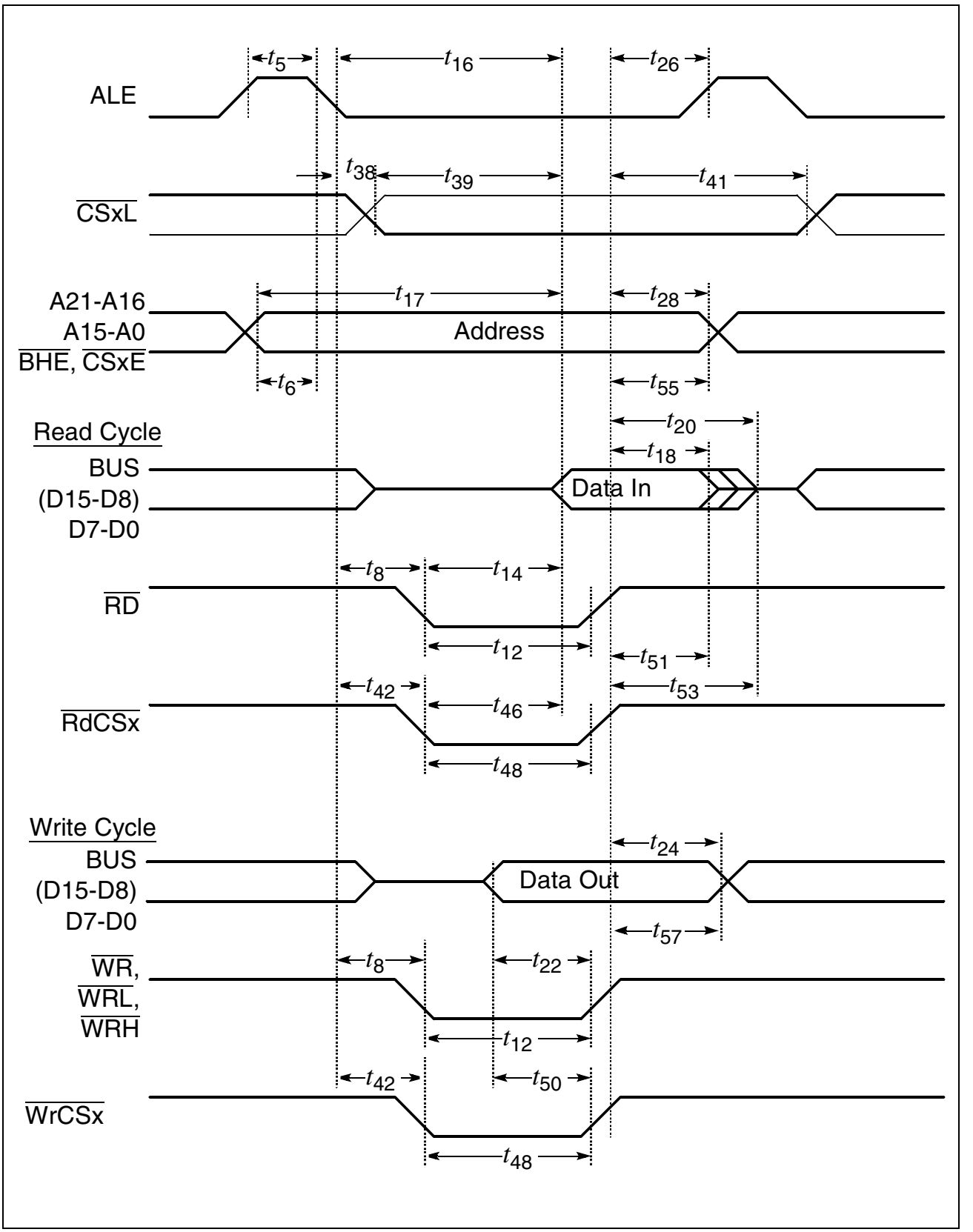


Figure 20 External Memory Cycle:
Demultiplexed Bus, With Read/Write Delay, Normal ALE

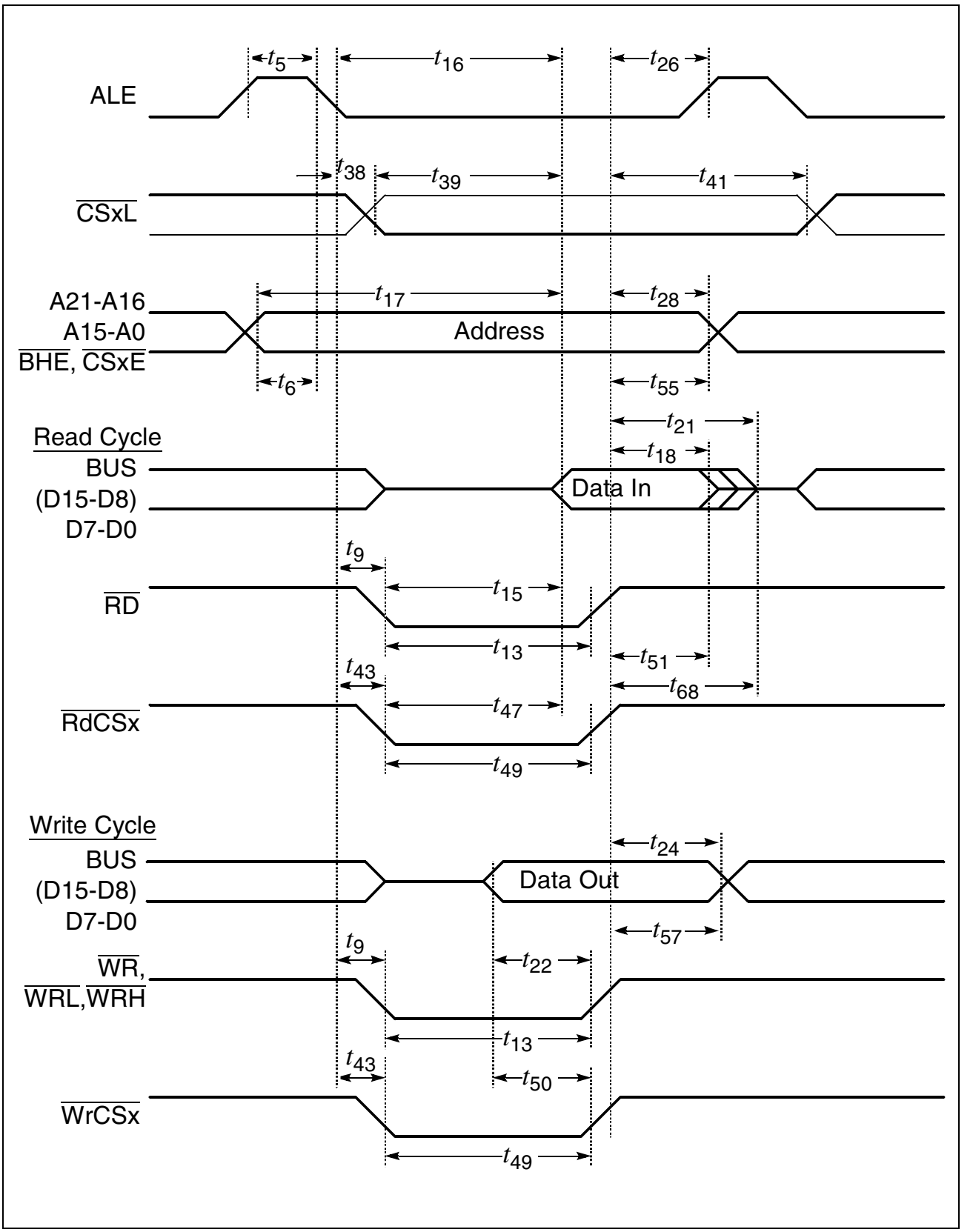


**Figure 22 External Memory Cycle:
Demultiplexed Bus, No Read/Write Delay, Normal ALE**

AC Characteristics

CLKOUT

(Operating Conditions apply)

Parameter	Symbol	Max. CPU Clock = 25 MHz		Variable CPU Clock 1 / 2TCL = 1 to 25 MHz		Unit
		min.	max.	min.	max.	
CLKOUT cycle time	t_{29} CC	40	40	2TCL	2TCL	ns
CLKOUT high time	t_{30} CC	14	–	TCL - 6	–	ns
CLKOUT low time	t_{31} CC	10	–	TCL - 10	–	ns
CLKOUT rise time	t_{32} CC	–	4	–	4	ns
CLKOUT fall time	t_{33} CC	–	4	–	4	ns
CLKOUT rising edge to ALE falling edge	t_{34} CC	$0 + t_A$	$10 + t_A$	$0 + t_A$	$10 + t_A$	ns

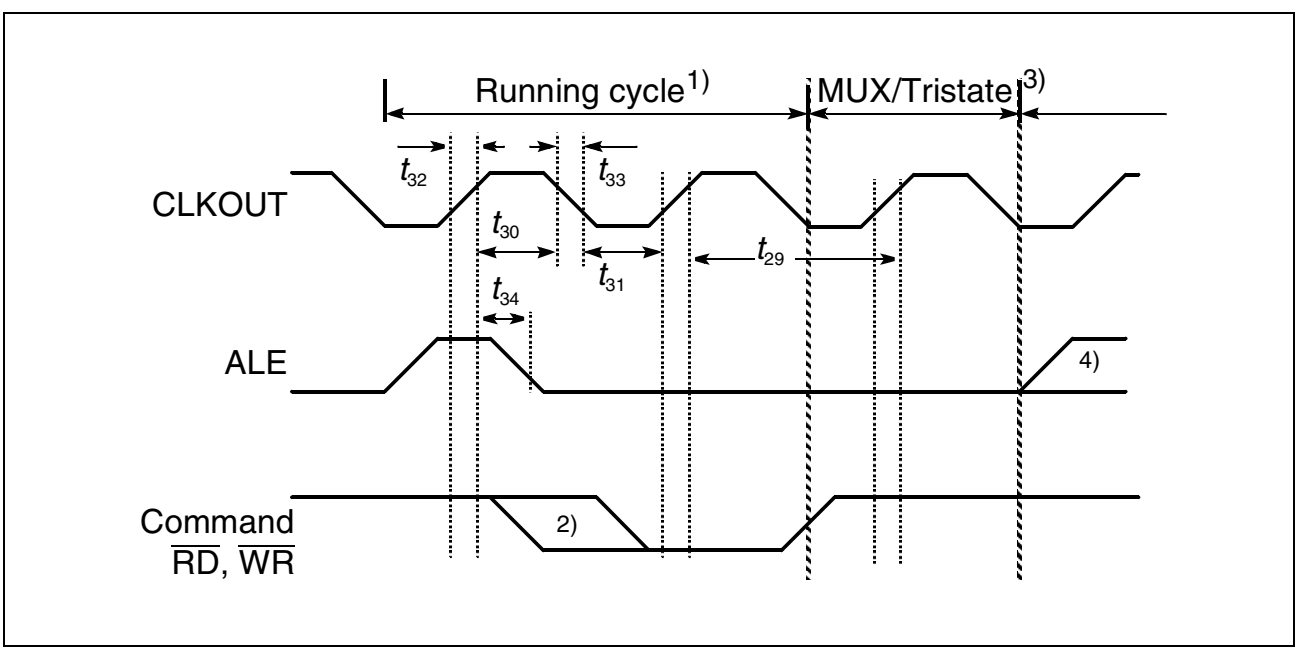


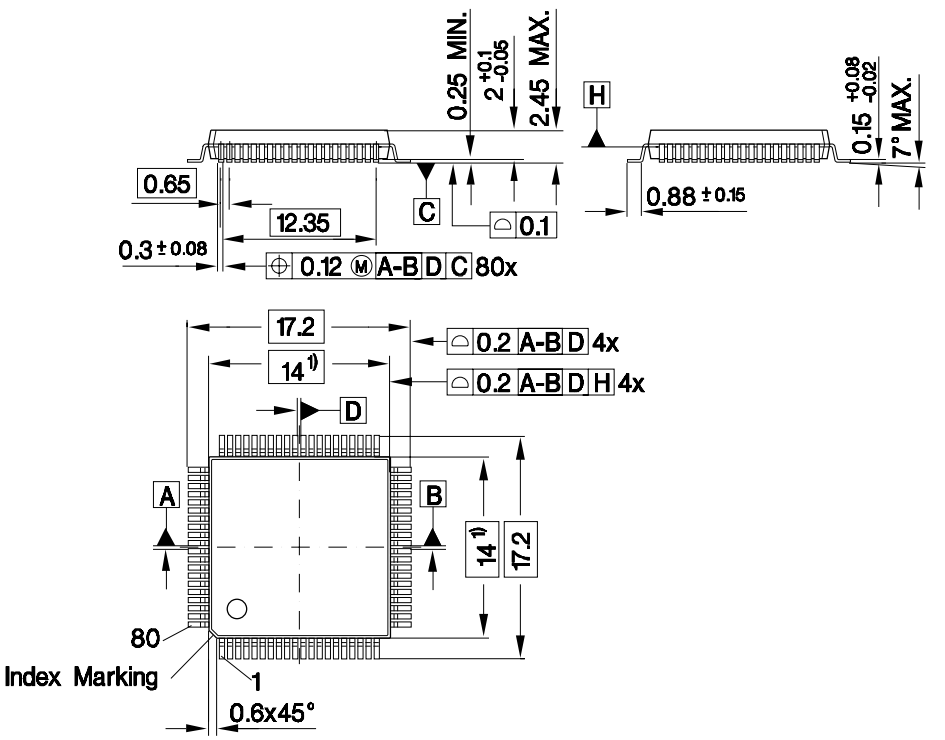
Figure 24 CLKOUT Timing

Notes

1) Cycle as programmed, including MCTC waitstates (Example shows 0 MCTC WS).
2) The leading edge of the respective command depends on RW-delay.
3) Multiplexed bus modes have a MUX waitstate added after a bus cycle, and an additional MTTC waitstate may be inserted here.
For a multiplexed bus with MTTC waitstate this delay is 2 CLKOUT cycles, for a demultiplexed bus without MTTC waitstate this delay is zero.
4) The next external bus cycle may start here.

Package Outlines

P-MQFP-80-7
(Plastic Metric Quad Flat Package)



1) Does not include plastic or metal protrusion of 0.25 max. per side

GPM05249

Sorts of Packing
Package outlines for tubes, trays etc. are contained in our Data Book “Package Information”.

SMD = Surface Mounted Device

Dimensions in mm